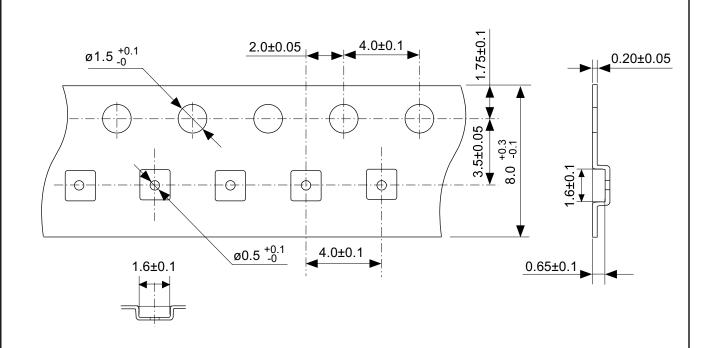
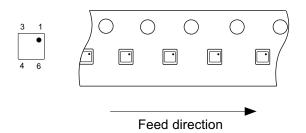


The heat sink of back side has different electric potential depending on the product.
Confirm specifications of each product.
Do not use it as the function of electrode.

No. PV006-A-P-SD-2.0

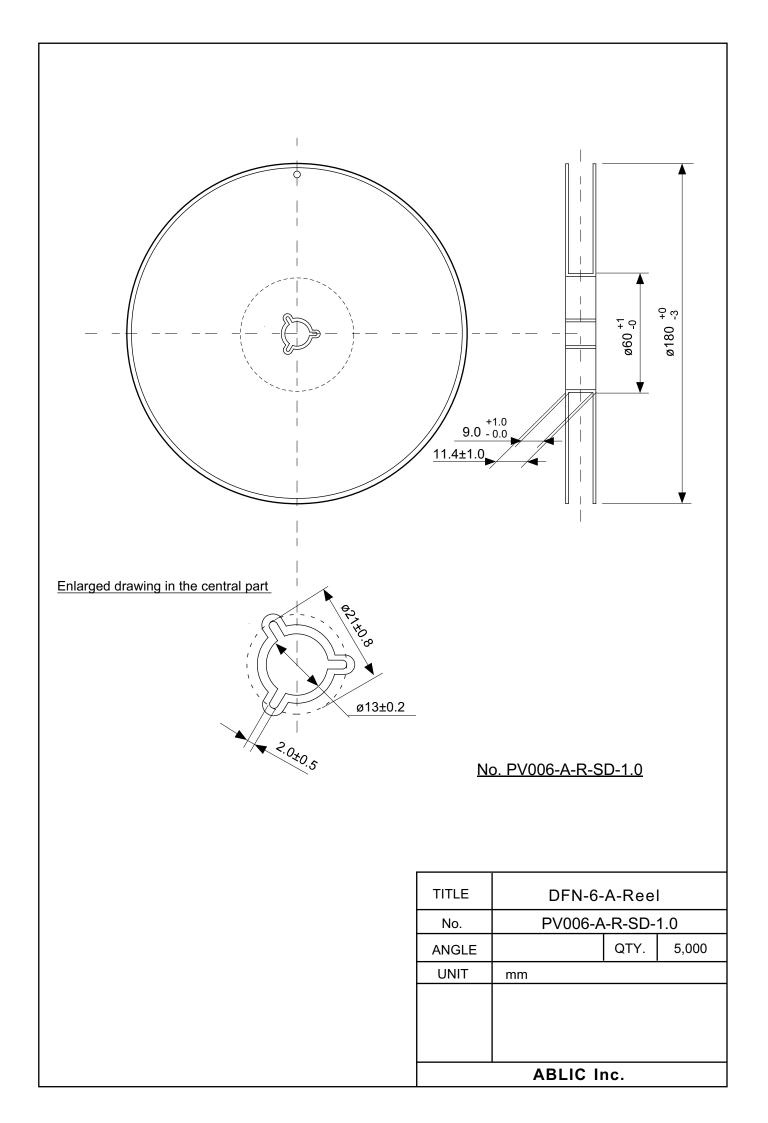
TITLE	DFN-6-A-PKG Dimensions	
No.	PV006-A-P-SD-2.0	
ANGLE		
UNIT	mm	
ABLIC Inc.		

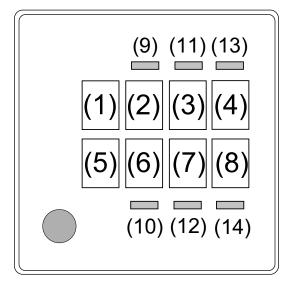




No. PV006-A-C-SD-1.0

TITLE	DFN-6-A-Carrier Tape		
No.	PV006-A-C-SD-1.0		
ANGLE			
UNIT	mm		
ABLIC Inc.			





(1) to (4) : Product code

(5) : Assembly code

(6) to (8) : Lot No.

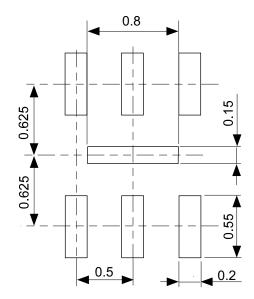
(9), (10) : Year of assembly (bar)

(11) to (14): Month of assembly (bar)

: 1 Pin mark

No. PV006-A-M-SD-1.0

TITLE	DFN-6-A- Markings		
No.	PV006-A-M-SD-1.0		
ANGLE			
UNIT		TYPE	LASER
ABLIC Inc.			



Caution It is recommended to solder the heat sink to a board in order to ensure the heat radiation.

注意 放熱性を確保する為に、PKGの裏面放熱板(ヒートシンク)を基板に 半田付けする事を推奨いたします。

No. PV006-A-L-SD-1.0

TITLE	DFN-6-A -Land Recommendation		
No.	PV006-A-L-SD-1.0		
ANGLE			
UNIT	mm		
ABLIC Inc.			